

FIG. 1
(RELATED ART)

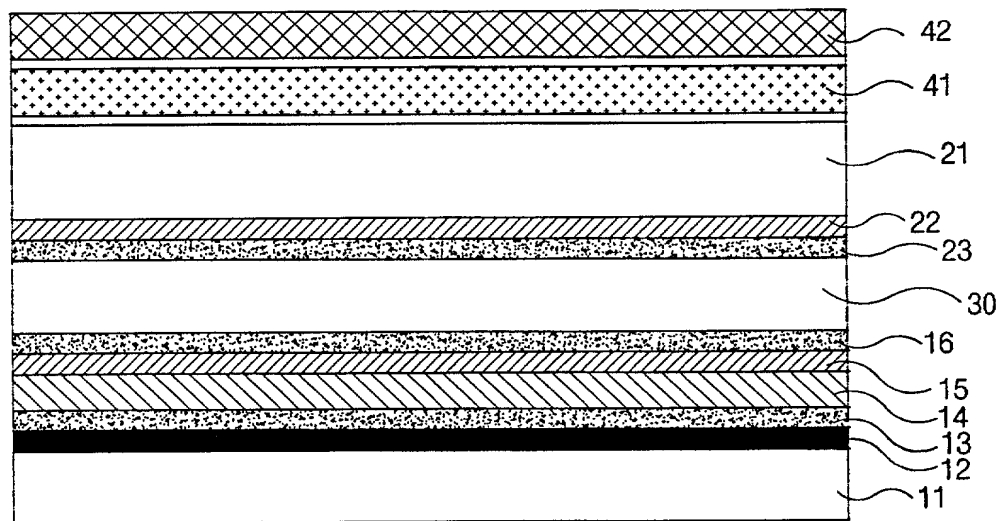


FIG. 2
(RELATED ART)

FIG. 3 is a cross-sectional view of a device 100. The device 100 includes a substrate 110, a first layer 120, a second layer 130, a third layer 140, a fourth layer 150, a fifth layer 160, a sixth layer 210, a seventh layer 220, an eighth layer 230, a ninth layer 300, a tenth layer 410, an eleventh layer 420, and a twelfth layer 500. The layers 110, 120, 130, 140, 150, 160, 210, 220, 230, 300, 410, 420, and 500 are stacked on top of each other. The layers 110, 120, 130, 140, 150, 160, 210, 220, 230, 300, 410, 420, and 500 have different patterns or textures. The layer 110 is a solid black layer. The layer 120 is a solid white layer. The layer 130 is a solid black layer. The layer 140 is a solid white layer. The layer 150 is a solid black layer. The layer 160 is a solid white layer. The layer 210 is a solid white layer. The layer 220 is a solid black layer. The layer 230 is a solid white layer. The layer 300 is a solid white layer. The layer 410 is a solid black layer. The layer 420 is a solid white layer. The layer 500 is a solid black layer.

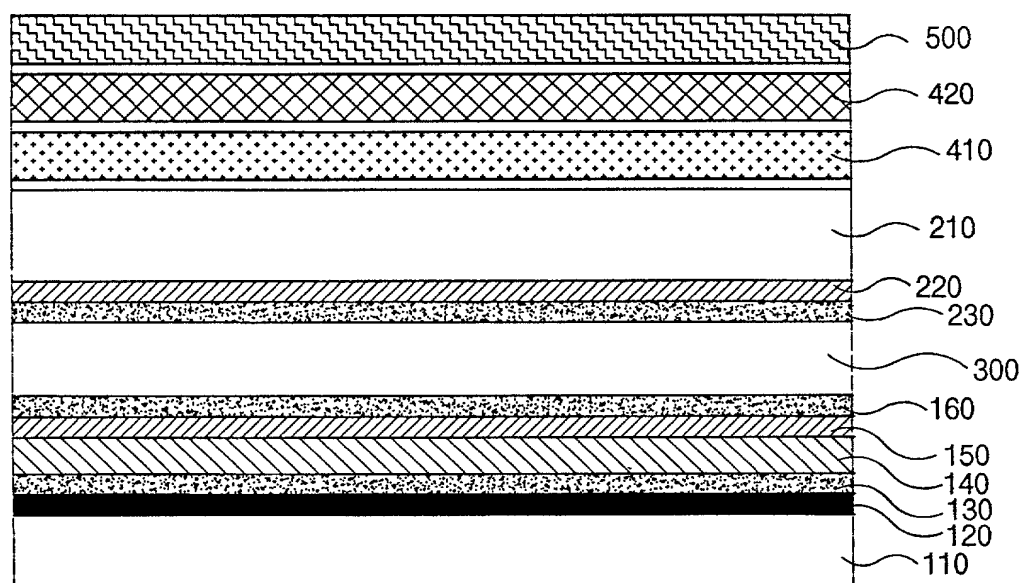


FIG. 3

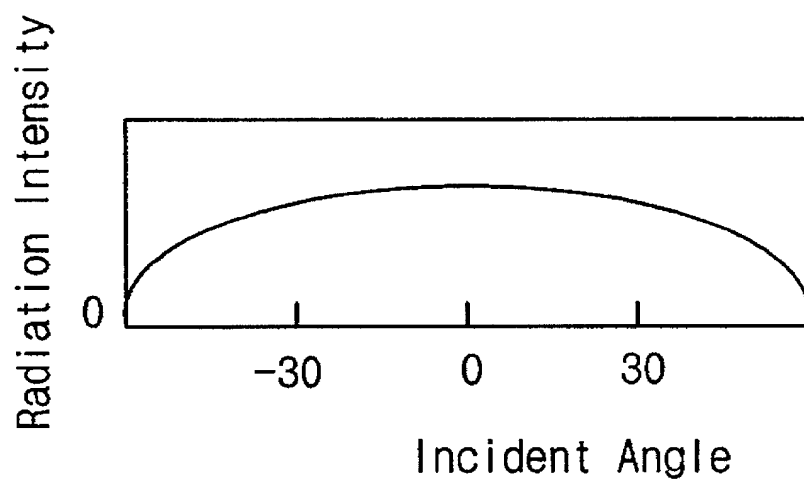


FIG. 4A

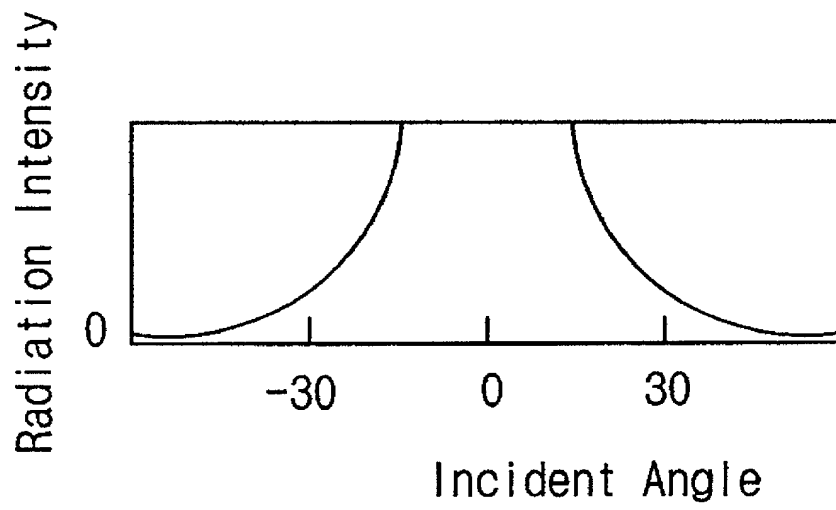


FIG. 4B

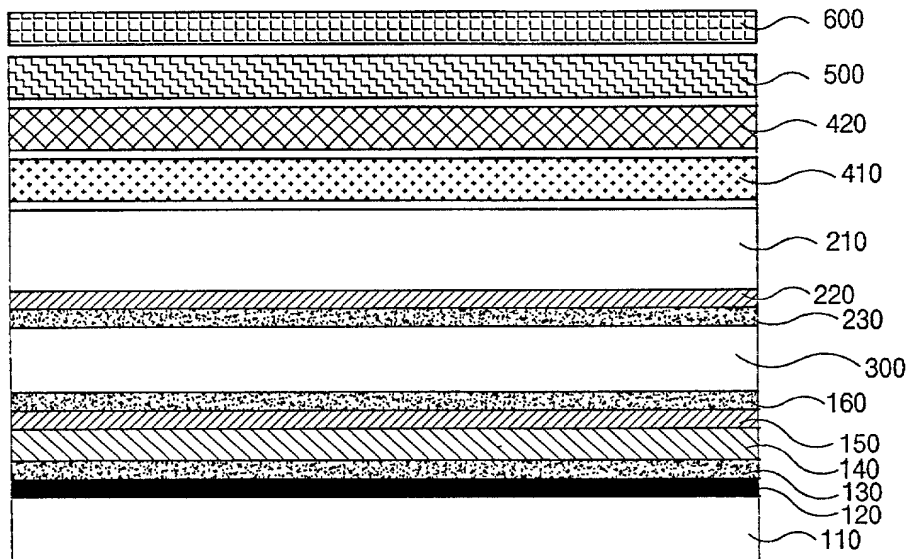


FIG. 5

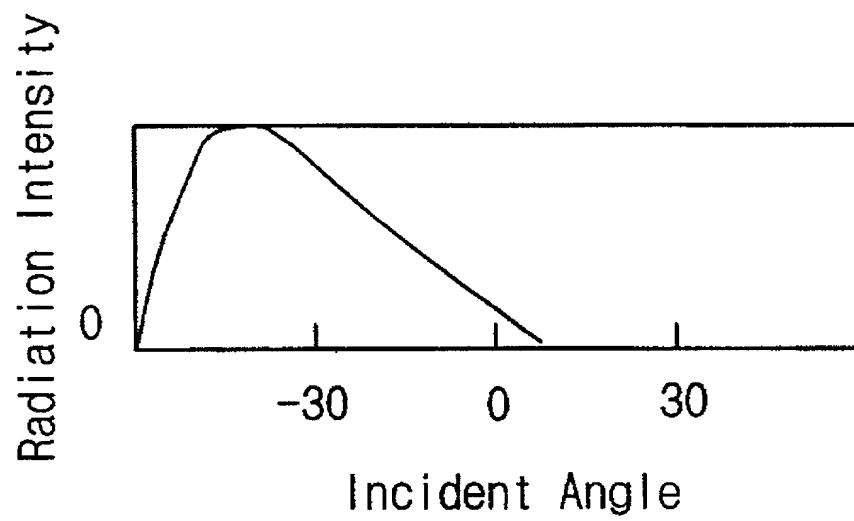


FIG. 6A

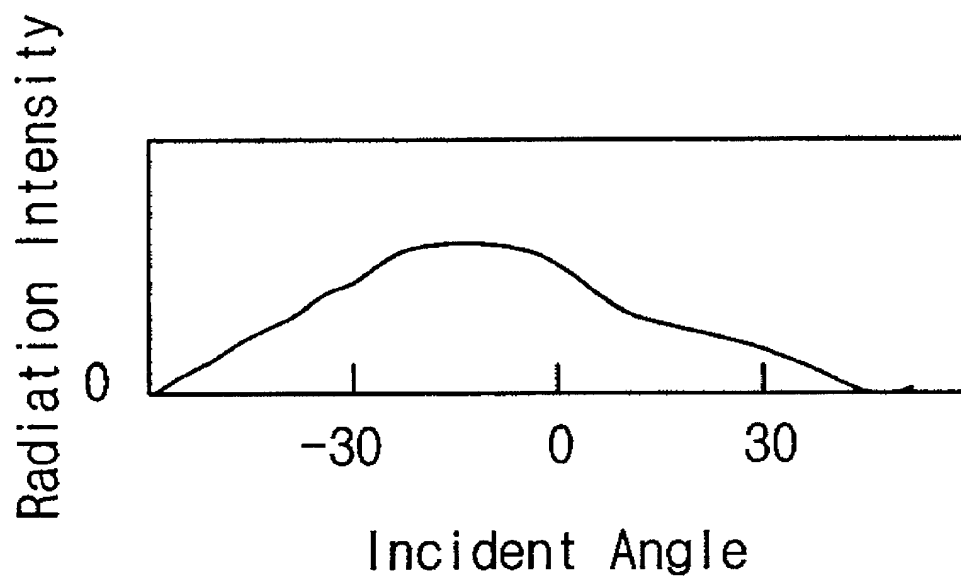


FIG. 6B

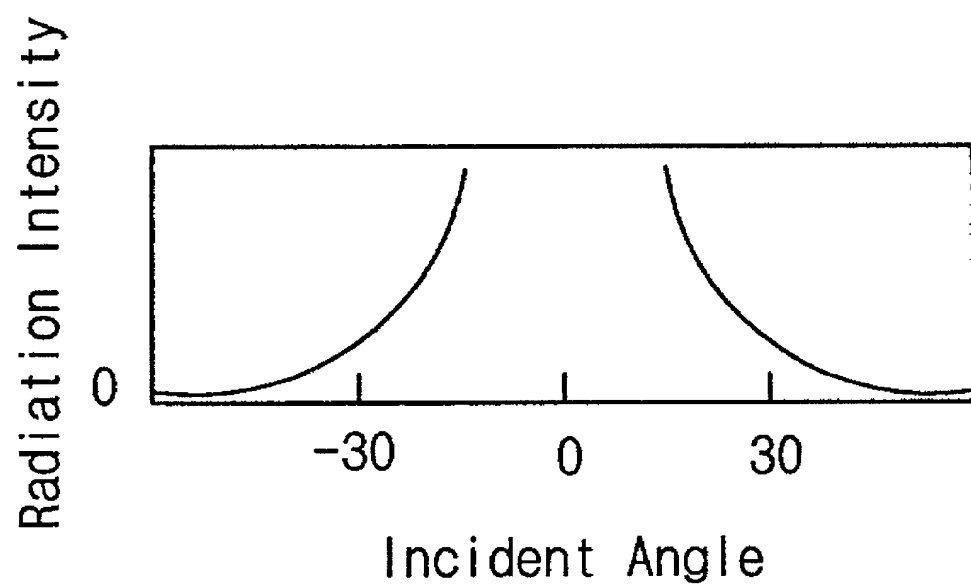


FIG. 6C